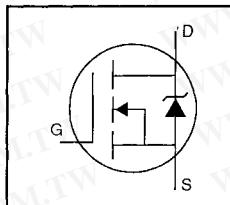


**IRFR420**

**IRFU420**

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR420)
- Straight Lead (IRFU420)
- Available in Tape & Reel
- Fast Switching
- Ease of Paralleling



$V_{DSS} = 500V$

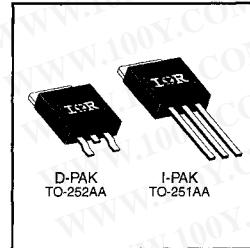
$R_{DS(on)} = 3.0\Omega$

$I_D = 2.4A$

### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D-Pak is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 watts are possible in typical surface mount applications.



### Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10 V$	2.4	
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10 V$	1.5	A
$I_{DM}$	Pulsed Drain Current ①	8.0	
$P_D @ T_C = 25^\circ C$	Power Dissipation	42	
$P_D @ T_A = 25^\circ C$	Power Dissipation (PCB Mount)**	2.5	W
	Linear Derating Factor	0.33	
	Linear Derating Factor (PCB Mount)**	0.020	W/°C
$V_{GS}$	Gate-to-Source Voltage	±20	V
$E_{AS}$	Single Pulse Avalanche Energy ②	400	mJ
$I_{AR}$	Avalanche Current ①	2.4	A
$E_{AR}$	Repetitive Avalanche Energy ①	4.2	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ ③	3.5	V/ns
$T_J, T_{STG}$	Junction and Storage Temperature Range	-55 to +150	
	Soldering Temperature, for 10 seconds	260 (1.6mm from case)	°C

### Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{JC}$	Junction-to-Case	—	—	3.0	
$R_{JA}$	Junction-to-Ambient (PCB mount)**	—	—	50	°C/W
$R_{UA}$	Junction-to-Ambient	—	—	110	

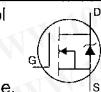
\*\* When mounted on 1" square PCB (FR-4 or G-10 Material).

For recommended footprint and soldering techniques refer to application note #AN-994.

Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	500	—	—	V	$V_{\text{GS}}=0\text{V}$ , $I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	0.59	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $I_D = 1\text{mA}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	3.0	$\Omega$	$V_{\text{GS}}=10\text{V}$ , $I_D = 1.4\text{A}$ ④
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D = 250\mu\text{A}$
$g_{\text{fs}}$	Forward Transconductance	1.5	—	—	S	$V_{\text{DS}}=50\text{V}$ , $I_D = 1.4\text{A}$ ④
$I_{\text{DS}}$	Drain-to-Source Leakage Current	—	—	25	$\mu\text{A}$	$V_{\text{DS}}=500\text{V}$ , $V_{\text{GS}}=0\text{V}$
	—	—	—	250		$V_{\text{DS}}=400\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J = 125^\circ\text{C}$
$I_{\text{GS}}$	Gate-to-Source Forward Leakage	—	—	100	$\text{nA}$	$V_{\text{GS}}=20\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}}=-20\text{V}$
$Q_g$	Total Gate Charge	—	—	19	$\text{nC}$	$I_D = 2.1\text{A}$
$Q_{\text{gs}}$	Gate-to-Source Charge	—	—	3.3		$V_{\text{DS}}=400\text{V}$
$Q_{\text{gd}}$	Gate-to-Drain ("Miller") Charge	—	—	13		$V_{\text{GS}}=10\text{V}$ See Fig. 6 and 13 ④
$t_{\text{d(on)}}$	Turn-On Delay Time	—	8.0	—	$\text{ns}$	$V_{\text{DD}}=250\text{V}$
$t_r$	Rise Time	—	8.6	—		$I_D = 2.1\text{A}$
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	33	—		$R_G=18\Omega$
$t_f$	Fall Time	—	16	—	$\text{nH}$	$R_D=120\Omega$ See Figure 10 ④
$L_D$	Internal Drain Inductance	—	4.5	—		
$L_S$	Internal Source Inductance	—	7.5	—		
$C_{\text{iss}}$	Input Capacitance	—	360	—	$\text{pF}$	
$C_{\text{oss}}$	Output Capacitance	—	92	—	$V_{\text{GS}}=0\text{V}$	
$C_{\text{rss}}$	Reverse Transfer Capacitance	—	37	—	$V_{\text{DS}}=25\text{V}$ $f=1.0\text{MHz}$ See Figure 5	

## Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	2.4		MOSFET symbol showing the integral reverse p-n junction diode.
$I_{\text{SM}}$	Pulsed Source Current (Body Diode) ④	—	—	8.0		
$V_{\text{SD}}$	Diode Forward Voltage	—	—	1.6		$T_J = 25^\circ\text{C}$ , $I_S = 2.4\text{A}$ , $V_{\text{GS}} = 0\text{V}$ ④
$t_{\text{rr}}$	Reverse Recovery Time	—	260	520	ns	$T_J = 25^\circ\text{C}$ , $I_r = 2.1\text{A}$
$Q_{\text{rr}}$	Reverse Recovery Charge	—	0.70	1.4	$\mu\text{C}$	$dI/dt = 100\text{A}/\mu\text{s}$ ④
$t_{\text{on}}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$ )				

Notes:

① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)

③  $I_{\text{SD}} \leq 2.4\text{A}$ ,  $di/dt \leq 50\text{A}/\mu\text{s}$ ,  $V_{\text{DD}} \leq V_{(\text{BR})\text{DSS}}$ ,  $T_J \leq 150^\circ\text{C}$ ②  $V_{\text{DD}} = 50\text{V}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 124\text{mH}$   
 $R_G = 25\Omega$ ,  $I_{\text{AS}} = 2.4\text{A}$  (See Figure 12)④ Pulse width  $\leq 300\ \mu\text{s}$ ; duty cycle  $\leq 2\%$ .

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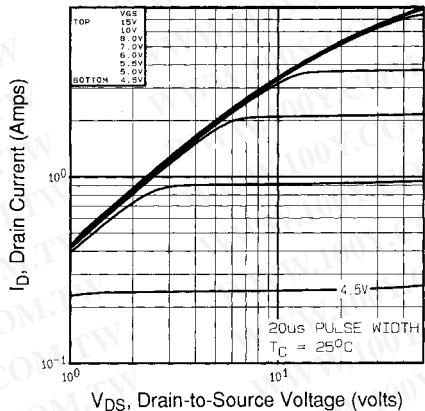


Fig 1. Typical Output Characteristics,  
 $T_C = 25^\circ\text{C}$

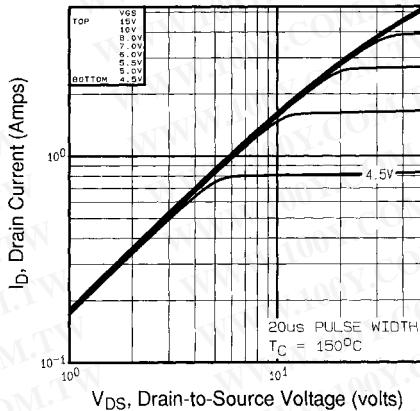


Fig 2. Typical Output Characteristics,  
 $T_C = 150^\circ\text{C}$

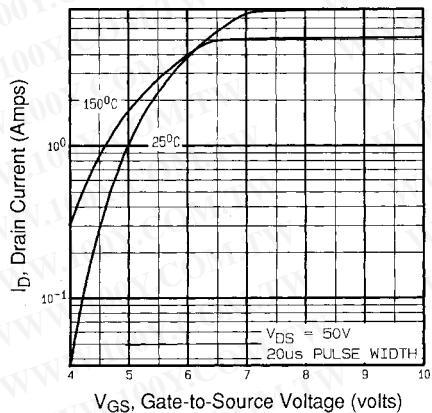


Fig 3. Typical Transfer Characteristics

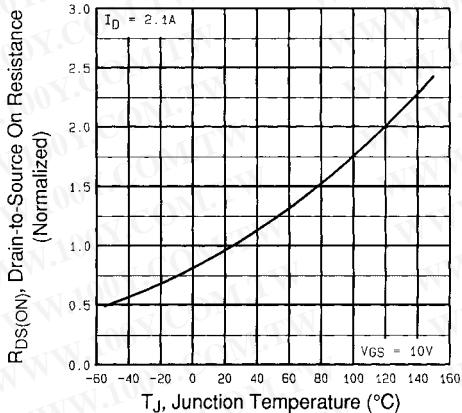


Fig 4. Normalized On-Resistance  
 Vs. Temperature

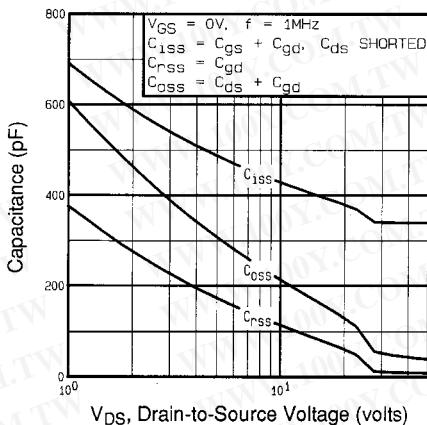


Fig 5. Typical Capacitance Vs.  
Drain-to-Source Voltage

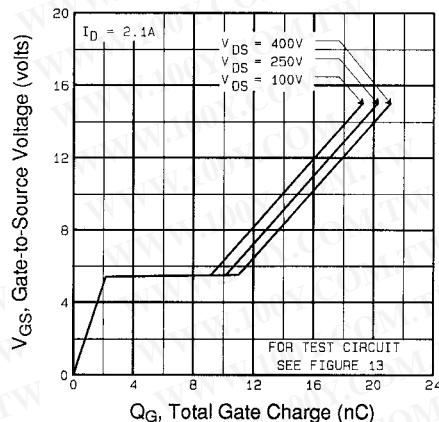


Fig 6. Typical Gate Charge Vs.  
Gate-to-Source Voltage

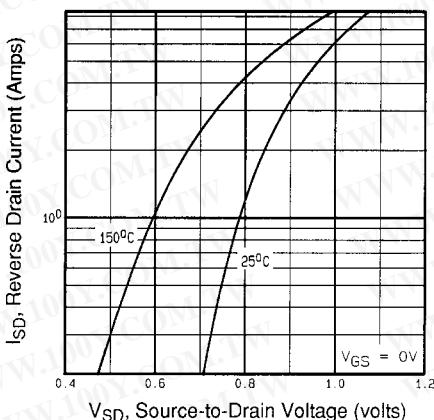
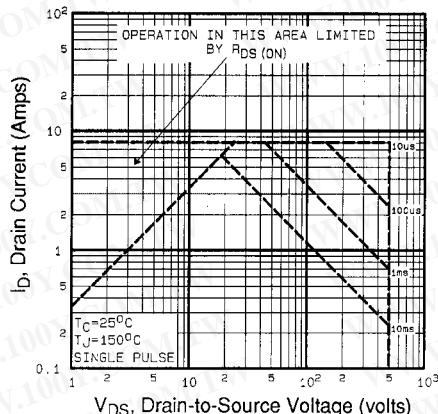


Fig 7. Typical Source-Drain Diode  
Forward Voltage



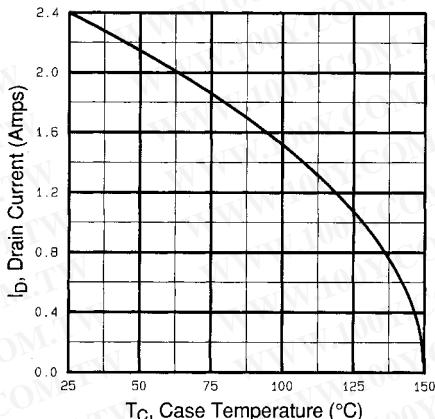


Fig 9. Maximum Drain Current Vs. Case Temperature

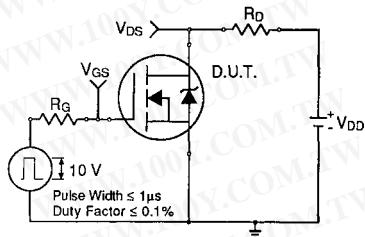
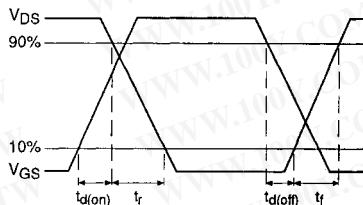


Fig 10a. Switching Time Test Circuit



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Fig 10b. Switching Time Waveforms

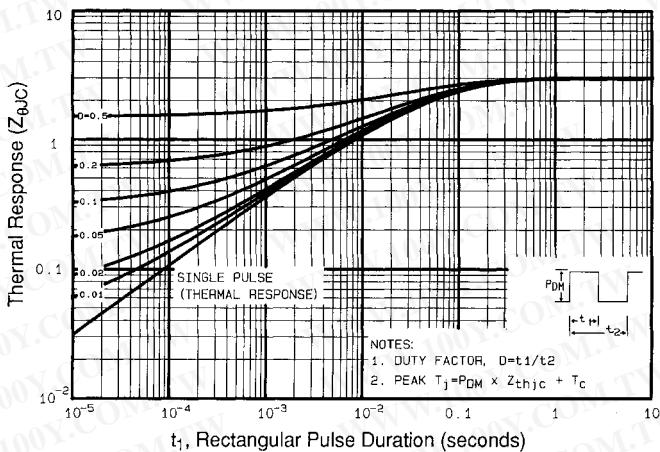


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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# IRFR420, IRFU420



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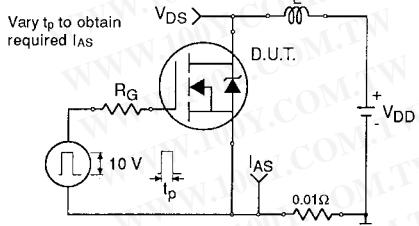


Fig 12a. Unclamped Inductive Test Circuit

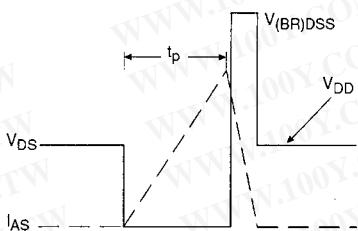


Fig 12b. Unclamped Inductive Waveforms

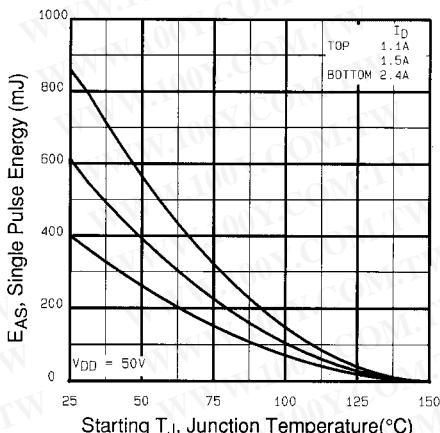


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

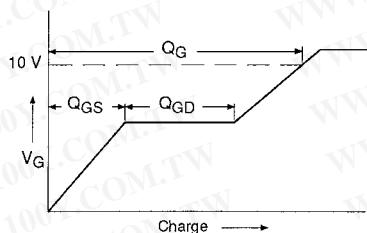


Fig 13a. Basic Gate Charge Waveform

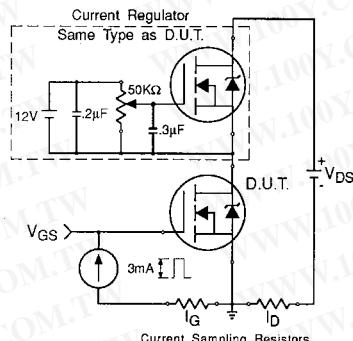


Fig 13b. Gate Charge Test Circuit

**Appendix A:** Figure 14, Peak Diode Recovery dv/dt Test Circuit – See page 1505

**Appendix B:** Package Outline Mechanical Drawing – See pages 1512, 1513

**Appendix C:** Part Marking Information – See page 1518

**Appendix D:** Tape & Reel Information – See page 1523

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